**Multilayer Ceramic Chip Capacitors** 

## C2012X5R1A225K085AA (TDK item description : C2012X5R1A225KT\*\*\*\*)

Applications		Commercial Grade
	Δ	Please refer to Part No. CGA4J2X5R1A225K125AA for automotive use.
Feature	General	General (Up to 50V)
Series	C2012 [EIA CC0805]	



Size		
Length(L)	2.00mm +/-0.20mm	
Width(W)	1.25mm +/-0.20mm	
Thickness(T)	0.85mm +/-0.15mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.50mm Min.	
Recommended Land Pattern(PA)	1.00 to 1.30mm (Flow Soldering) 0.90 to 1.20mm (I	Reflow Soldering)
Recommended Land Pattern(PB)	1.00 to 1.20mm (Flow Soldering) 0.70 to 0.90mm (I	Reflow Soldering)
Recommended Land Pattern(PC)	0.80 to 1.10mm (Flow Soldering) 0.90 to 1.20mm (I	Reflow Soldering)
Recommended Slit Pattern(SD)		

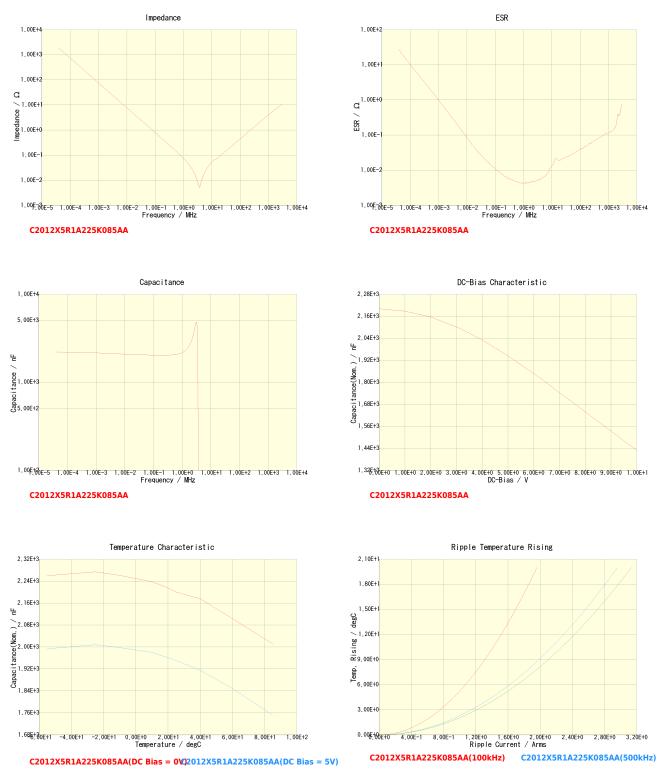
Electrical Characteristics				
Capacitance	2.2uF +/-10%			
Rated Voltage	10Vdc			
Temperature Characteristic	X5R(+/-15%)			
Dissipation Factor	5% Max.			
Insulation Resistance	45MΩ Min.			

Other				
Soldering Method	Reflow, Flow			
AEC Q200	No			
Packing	Punched (Paper)Taping [180mm Reel]			
Package Quantity	4000Pcs Min.			

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Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



C2012X5R1A225K085AA(1MHz)

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